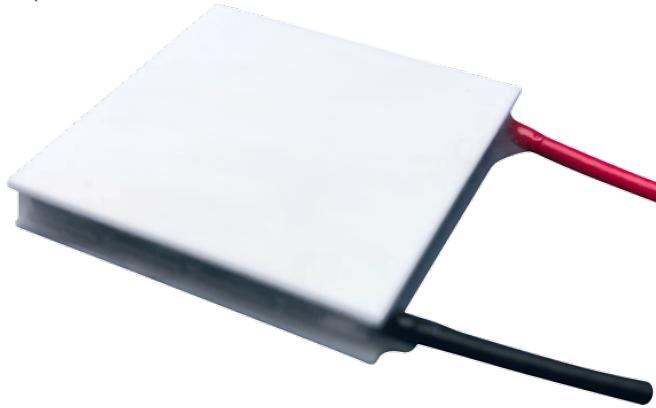


HiTemp ETX Series Thermolectric Cooler

The ETX14-3-F1-3030-TB-EP-W6 high temperature, high-performance thermoelectric cooler uses Laird Thermal Systems' enhanced thermoelectric module construction preventing performance degrading diffusion, which is common in standard grade thermoelectric coolers operating in high temperature environments exceeding 80 °C. It has a maximum Q_c of 33.8 Watts when $\Delta T = 0$ and a maximum ΔT of 83.2 °C at $Q_c = 0$.

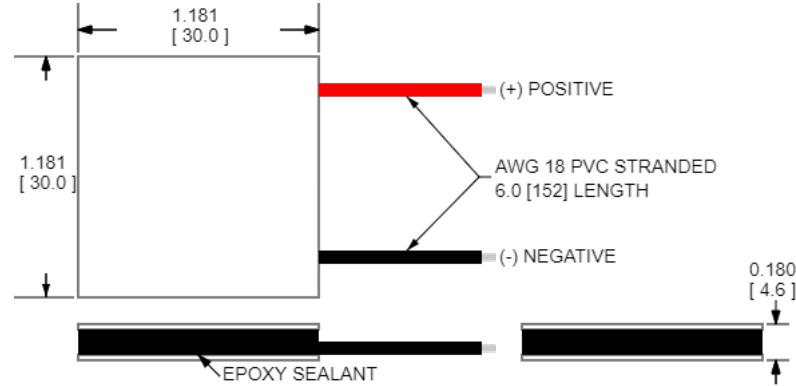


Features

- High-temperature operation
- Reliable solid-state
- No sound or vibration
- Environmentally-friendly
- RoHS-compliant

Applications

- Peltier Cooling for Refrigerated Centrifuges
- Peltier Cooling for Machine Vision
- Thermoelectric Cooling for CMOS Sensors
- Cooling Solutions for Autonomous Systems
- Peltier Cooling for Digital Light Processors
- Heating and Cooling for Liquid Chromatography Systems
- Thermoelectric Cooling for Security Cameras



CERAMIC MATERIAL: Al_2O_3

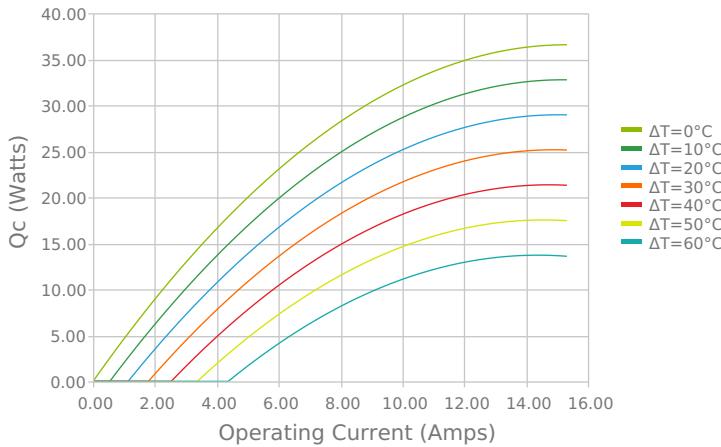
SOLDER CONSTRUCTION: 232°C, SbSn

INCHES [MM]

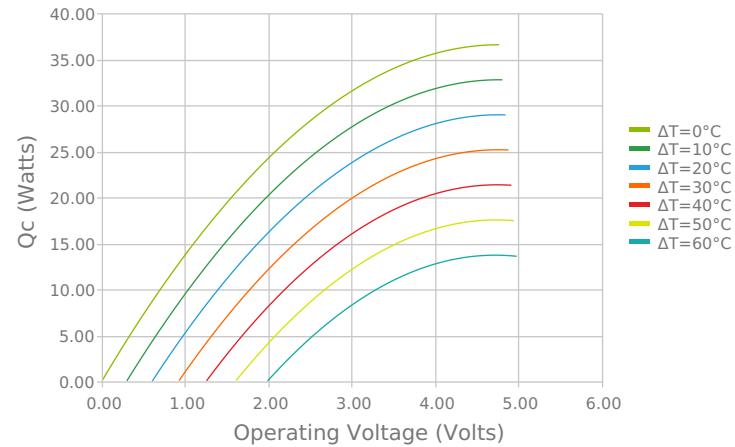
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

ELECTRICAL AND THERMAL PERFORMANCE

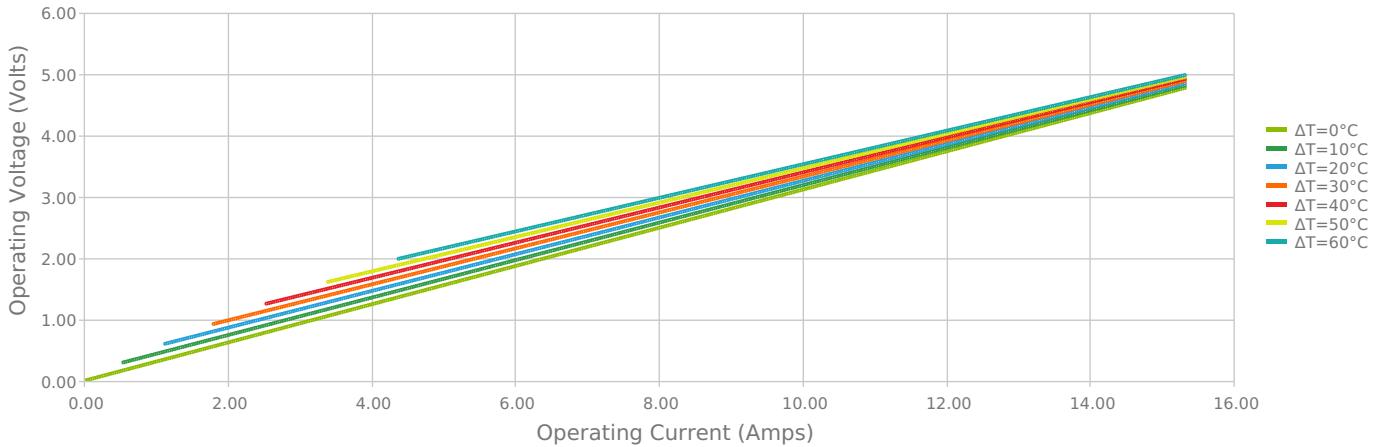
Heat Pumped at Cold Side
Thot = 85 °C

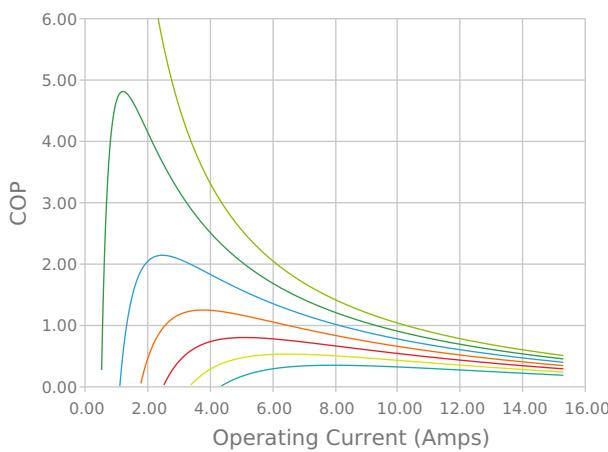
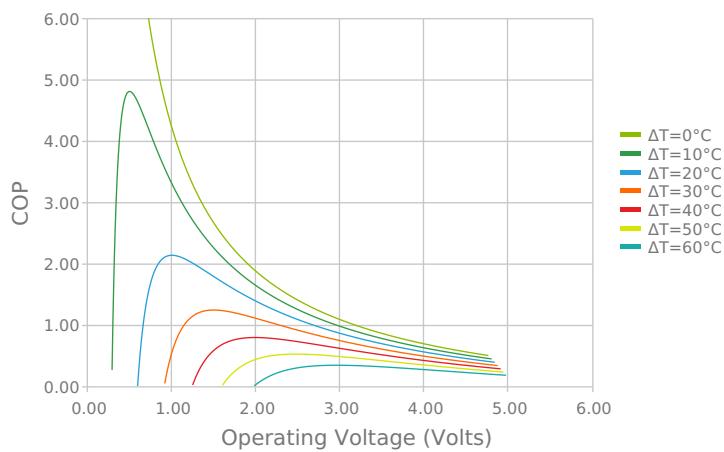
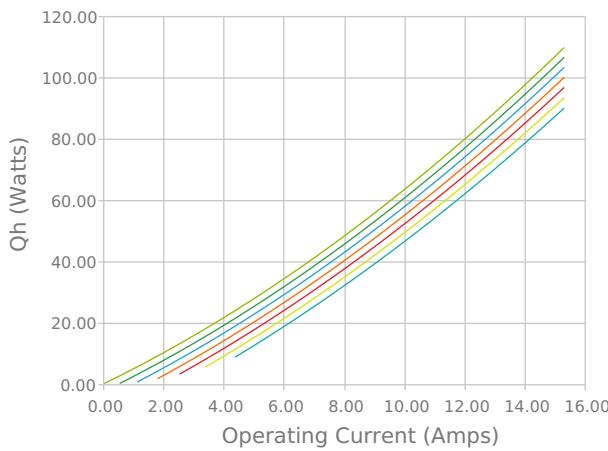
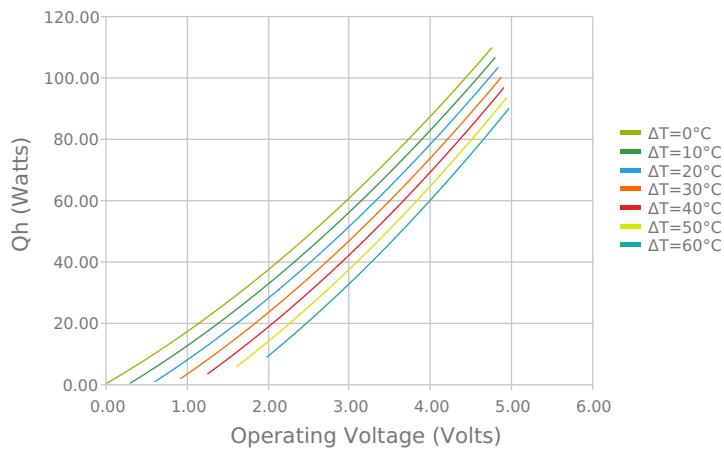
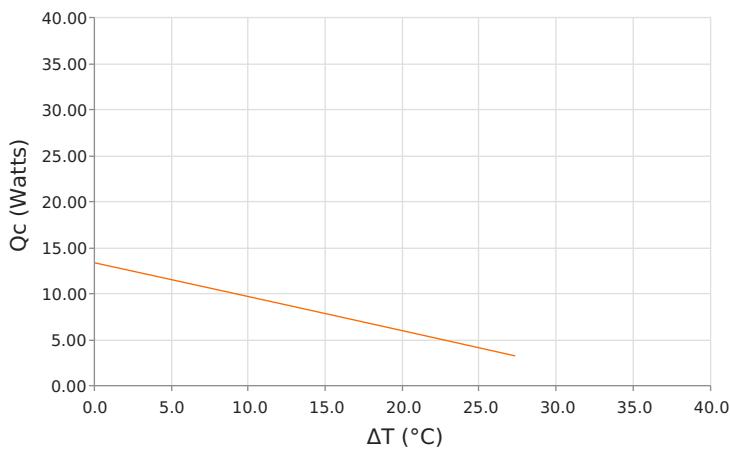
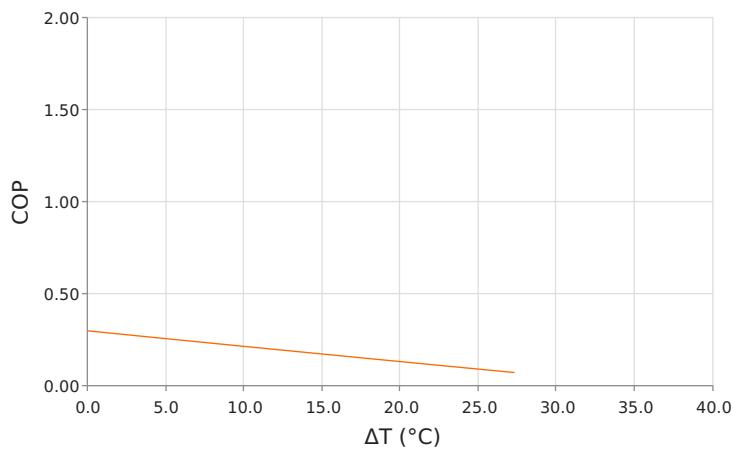


Heat Pumped at Cold Side
Thot = 85 °C



Current vs Voltage (I vs V)
Thot = 85 °C



Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 85^\circ C$

 Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 85^\circ C$

 Total Heat Dissipated at Hot Side ($Q_h = Q_c + P_{in}$)
 $T_{hot} = 85^\circ C$

 Total Heat Dissipated at Hot Side ($Q_h = Q_c + P_{in}$)
 $T_{hot} = 85^\circ C$

 Heat Pumped at Cold Side (Q_c)
 $T_{hot} = 85^\circ C$ | Current = 11.5 Amps

 Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 85^\circ C$ | Current = 11.5 Amps


SPECIFICATIONS*

	50.0 °C	85.0 °C	110.0 °C
Qcmax (ΔT = 0)	33.8 Watts	36.6 Watts	37.7 Watts
ΔTmax (Qc = 0)	83.2°C	95.3°C	102.0°C
I_{max} (I @ ΔT_{max})	14.1 Amps	13.6 Amps	13.3 Amps
V_{max} (V @ ΔT_{max})	4.1 Volts	4.7 Volts	5.1 Volts
Module Resistance	0.27 Ohms	0.31 Ohms	0.34 Ohms
Max Operating Temperature	150 °C		
Weight	19.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
TB	4.572 ± 0.013 mm 0.180 ± 0.0005 in	0.013 mm / 0.013 mm 0.0005 in / 0.0005 in	Lapped	Lapped	152.4 mm 6.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Epoxy	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

NOTES

1. Max operating temperature: 150°C
2. Do not exceed I_{max} or V_{max} when operating module
3. Reference assembly guidelines for recommended installation

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